

XT3408SPQ4



GaAs MMIC Digital Attenuator
DC~12GHz

Rev 1.3

Features

- Frequency: DC~12GHz
- RMS of Attenuation Accuracy: 1dB
- Insertion Loss: 2.8dB
- Positive Voltage Control
- Size: 4mm×4mm×1.2mm

Typical Applications

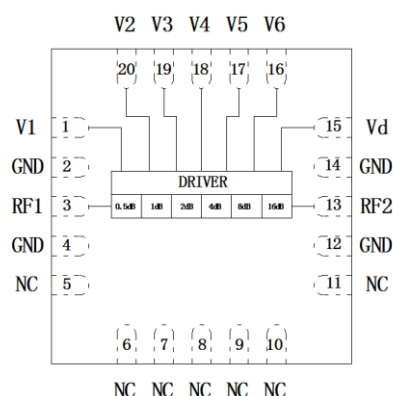
- EW
- Cellular Infrastructure
- SATCOM
- Beamforming Modules
- Test Equipment and Sensors

General Description

XT3408SPQ4 is a broadband 6-bit GaAs digital attenuator MMIC chip. Covering DC to 12GHz, the insertion loss is less than 3.5 dB typically. The attenuator bit values are 0.5dB, 1dB, 2dB, 4dB, 8dB and 16dB for a total attenuation of 31.5dB. Three TTL 0/+5V inputs are used to select each attenuation state.

The chip offers full passivation for increased reliability and moisture protection.

Functional Diagram



Electrical Performance ($T_A=+25^{\circ}\text{C}$, $V_d=-5\text{V}$, Control Voltage=0/+5V, $Z_0=50\Omega$)

Parameter	Min.	Typ.	Max.	Units
Frequency	DC~12			GHz
Input VSWR	-	1.3	1.6	:1
Output VSWR	-	1.3	1.6	:1
Insertion Loss	-	-2.8	-3.5	dB
A_{TT} -Phase Error	-3	-	5	°
Attenuation Accuracy	-1	-	3.5	dB
RMS of Attenuation Accuracy	-	1	2	dB

Truth Table (0 : 0V, 1 : +5V)

Attenuation	V1	V2	V3	V4	V5	V6
REF	0	0	0	0	0	0
0.5dB	5	0	0	0	0	0
1dB	0	5	0	0	0	0
2dB	0	0	5	0	0	0
4dB	0	0	0	5	0	0
8dB	0	0	0	0	5	0
16dB	0	0	0	0	0	5
31.5dB	5	5	5	5	5	5

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Control Voltage

State	Bias
Low	0~0.5V
High	4.5~5.5V

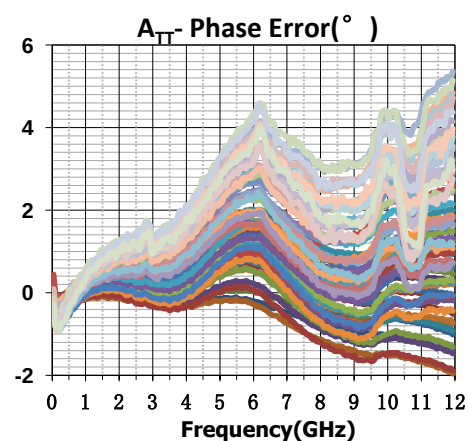
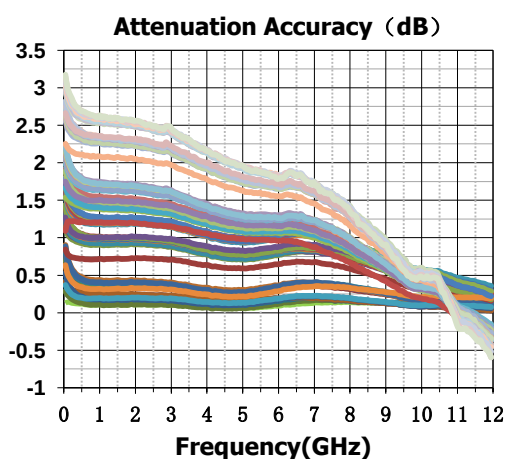
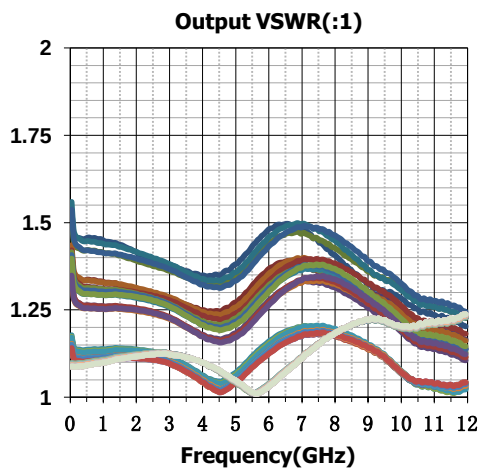
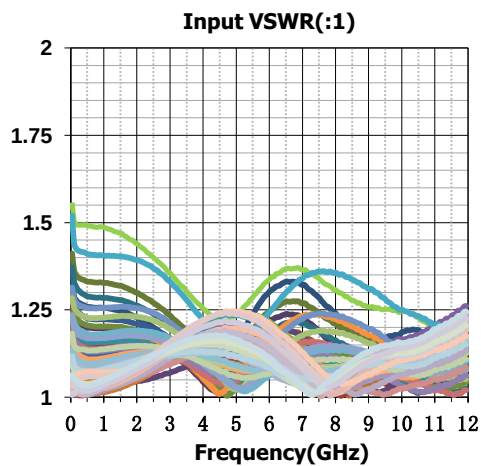
Absolute Maximum Ratings

Maximum Input Power	Maximum Input Voltage
+23dBm	-8V
Operating Temperature	Storage Temperature
-55°C ~ +85°C	-65°C ~ +150°C

Power Supply

V _D	I _D
-5V	4mA

Typical Performance Curve

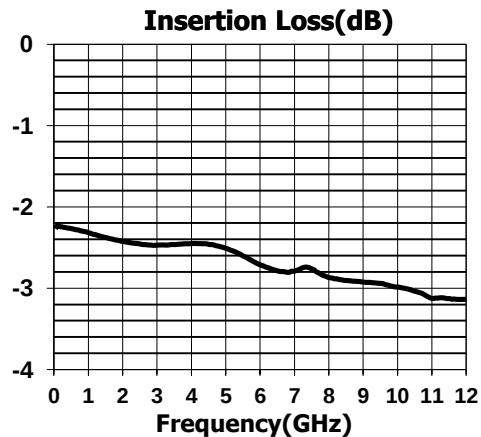
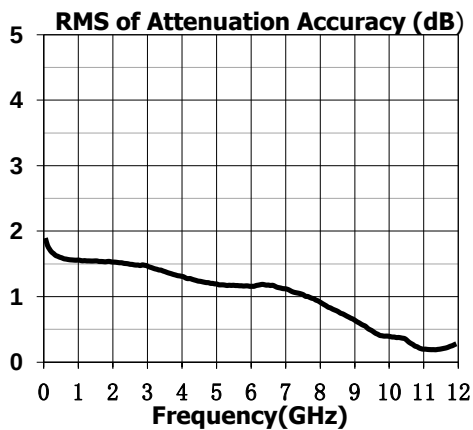


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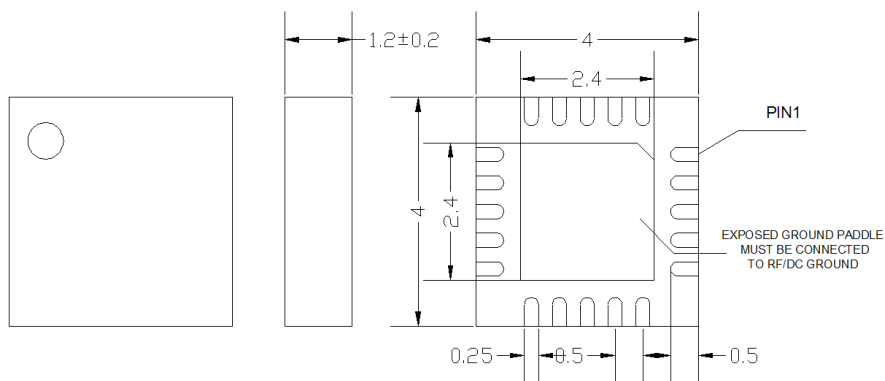


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Outline (all dimensions in mm)



Attention:

1. The moisture resistant grade of products is 2A, the storage environment $\leq 30^{\circ}\text{C}/60\%\text{RH}$. The surrounding workshop Life is 4 weeks.
2. After un-packing, It is necessary to bake the parts for 6 hours in 125 ± 5 degree environment before soldering.